



# **LCD MODULE**

# MODULE NO.:

# KSECB2002XXX-R01 SERIES

Approved by:		
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### **RECORDS OF REVISION**

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### **CONTENTS**

1. MODULE CLASSIFICATION INFORMATION	4
2. FUNCTIONS & FEATURES	5
3. MECHANICAL SPECIFICATIONS	5
4. EXTERNAL DIMENSIONS	6
5. BLOC`K DIAGRAM	7
6. PIN ASSIGNMENT	7
7. BACKLIGHT ELECTRICAL/OPTICAL SPECIFICATIONS	8
8. DISPLAY DATA RAM (DDRAM)	8
9. MAXIMUM ABSOLUTE POWER RATINGS	8
10. ELECTRICAL CHARACTERISTICS	9
11. INSTRUCTION TABLE	11
12. INITIALIZING BY INSTRUCTION	12
13. CHARACTER GENERATOR ROM	13
14. OPTICAL CHARACTERISTICS	14
15. MODULE ACCEPT QUALITY LEVEL (AQL)	16
16. RELIABILITY TEST	16
17. INSPECTION SPECIFICATION	17
18. LCD MODULES HANDLING PRECAUTIONS	20
19 OTHERS	20

#### 1. MODULE CLASSIFICATION INFORMATION

### KSE C B 2002 X X X - R 01

(4)

(1) KSE: KEEN SIDE electronics

(3)

(2)

② C: Character Type, G: Graphic Type

③ B: COB, G: COG

 $\widehat{(1)}$ 

4 Display Font: 20 \* 2

5 LCD Mode: B→ STN-Blue Negative F→ FSTN Positive

(5) (6) (7) (8) (9)

 $G \rightarrow STN$  Gray Positive  $Y \rightarrow STN$  Yellow Green Positive

⑥ Backlight Type:  $N \rightarrow Without backlight$   $A \rightarrow Amber LED backlight$ 

 $B \rightarrow Blue LED$  backlight  $G \rightarrow Green LED$  backlight

R→ Red LED backlight W→ Withe LED backlight

Y→ Yellow-Green LED backlight

7 LCD Polarizer Type/Temperature range/View direction :

D→ Transflective, W.T, 12:00 E→ Transmissive, W.T, 6:00

P→ Reflective, W. T, 6:00 Q→ Transmissive, W.T, 12:00

Z→ Transflective, W.T, 6:00

(8) Character Bank:

A→ English / Japan B→ English / European

R→English / Cyrillic / Portuguese / Russian

 $T \rightarrow English / Russian \qquad G \rightarrow Hebrew$ 

Model serials no.:

### **KSECB2002XXX-R01 SERIES**

#### 2. FUNCTIONS & FEATURES

• KSECB2002XXX-R01 Series LCD type:

• Display Contents :20\* 2 Characters (5\*8 dots)

Driving Scheme : 1/16Duty; 1/5Bias
 Driver IC :AIP31066L-002

• Interface :Parallel

Operating Temperature
 Storage Temperature
 :-20 C - + 70 C
 :-30 C - + 80 C

• RoHS Compliant

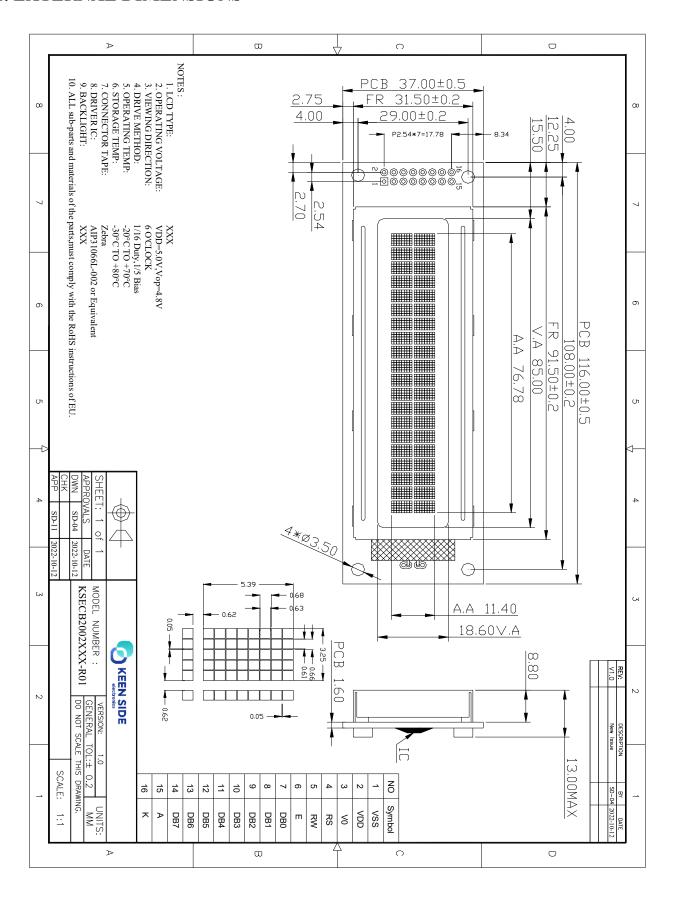
#### 3. MECHANICAL SPECIFICATIONS

• Outline Dimensions : 116.00(W) x 37.00(L) x 13.00(H)(mm)

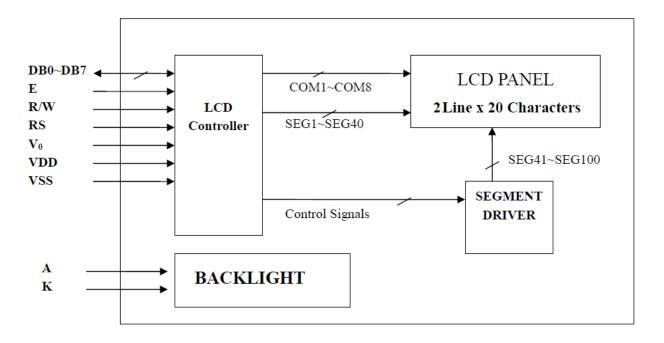
Viewing Area : 85.00 (W) x 18.60(L)(mm)
 Active Area : 76.78 (W) x 11.40 (L)(mm)
 Character Size : 3.25 (W) x 5.39 (L)(mm)
 Character Pitch : 3.87 (W) x 6.01 (L)(mm)
 Dot Size : 0.61 (W) x 0.63 (L)(mm)
 Dot Pitch : 0.66 (W) x 0.68 (L)(mm)

• Weight : TBD

#### 4. EXTERNAL DIMENSIONS



### 5. BLOC'K DIAGRAM



#### 6. PIN ASSIGNMENT

Pin No.	Symbol	Function							
1	VSS	Ground terminal of module.							
2	VDD	Power terminal of module							
3	V0	Power Supply for liquid crystal drive.							
		Register select							
4	RS	RS = 0···Instruction register							
		$RS = 1 \cdots Data register$							
		Read /Write							
5	R/W	$R/W = 1 \cdots Read$							
		R/W = 0···Write							
6	Е	Read/Write Enable Signal							
7	DB0								
8	DB1								
9	DB2	Bi-directional data bus, data transfer is performed once, thru DB0 to DB7,							
10	DB3	in the case of interface data. Length is 8-bits; and twice, thru DB4 to DB7 in							
11	DB4	the case of interface data length is 4-bits. Upper four bits first then lower							
12	DB5	four bits.							
13	DB6								
14	DB7								
15	A	Anode of Backlight							
16	K	Cathode of Backlight							

#### 7. BACKLIGHT ELECTRICAL/OPTICAL SPECIFICATIONS

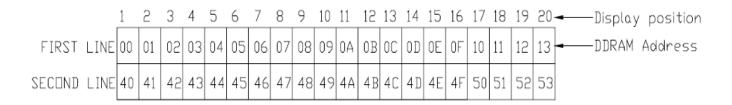
**Electrical/Optical Specifications (White)** 

21000110001 Specifications (++ mee)											
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS					
Forward Voltage	Vf	2.9	3.1	3.3	V	If= 15x2 mA					
Reverse Current	Ir			100	μΑ	Vr=5.0 V					
D	X	0.28		0.30		If= 15x2 mA					
Dominant wave length	Y	0.28		0.30	-						
Spectral Line Half width	Δλ				nm	If= 15x2 mA					
Luminous	Lv	70	80		cd/m <sup>2</sup>	If= 15x2 mA					

**Electrical/Optical Specifications (Yellow-Green)** 

need team optical opermeations (Tenow Green)											
ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS					
Forward Voltage	Vf	2.9	3.1	3.3	V	If= 15x2 mA					
Reverse Current	Ir			100	μΑ	Vr=5.0 V					
Dominant wave length	λD	569	572	575	nm	If= 15x2 mA					
Spectral Line Half width	Δλ		25		nm	If= 15x2 mA					
Luminous	Lv	75	80		cd/m <sup>2</sup>	If= 15x2 mA					

### 8. DISPLAY DATA RAM (DDRAM)



#### 9. MAXIMUM ABSOLUTE POWER RATINGS

Item	Symbol	Standard value	Unit
Power supply voltage(1)	VDD	-0.3~+7.0	V
Power supply voltage(2)	VLCD	VDD-10.0~VDD+0.3	V
Input voltage	VIN	-0.3~VDD+0.3	V
Operating temperature	Topr	-20~+70	$^{\circ}$
Storage temperature	Tstg	-30~+80	$^{\circ}$

<sup>\*</sup>Voltage greater than above may damage to the Circuit.

### 10. ELECTRICAL CHARACTERISTICS

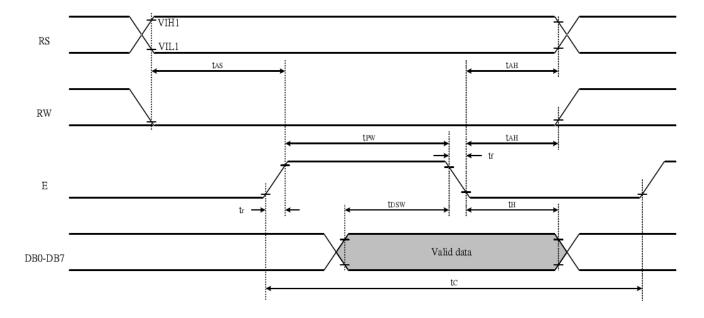
### 10-1 DC Characteristics

Item	Cymbol	St	andard Va	lue	Test	Unit	
nem	Symbol	MIN	TYP	MAX	Condition	Unit	
Operating Voltage	$V_{ m DD}$	4.8	5.0	5.2		V	
	$I_{\mathrm{DD1}}$		TBD	1.0	Ceramic oscillation fosc=250kHz		
Supply Current	$I_{\mathrm{DD2}}$		TBD	0.6	Resistor oscillation external clock operation fosc=270kHz	mA	
LCD Driving Voltage	VLCD	4.6	4.8	5.0	V <sub>DD</sub> -V <sub>0</sub>	V	

### 10-2 AC Characteristics

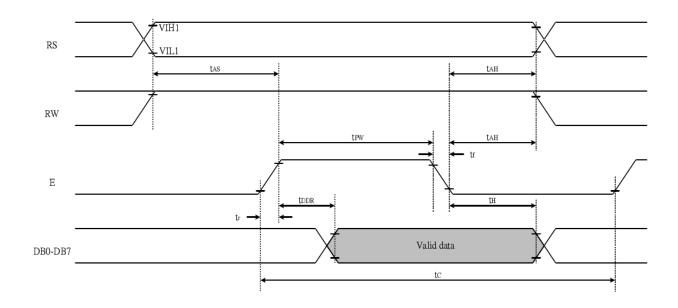
### 10.2.1 Write mode

Characteristic	Symbol	Min	Type	Max	Unit	Test PIN
Enable Cycle Time	t <sub>C</sub>	1200			ns	Е
Enable Pulse Time	$T_{PW}$	460			ns	Е
Enable Rise/Fall Time	$T_{R_{,}}T_{F}$			25	ns	Е
Address Set-up Time	T <sub>AS</sub>	0			ns	R/W,RS,E
Address Hold Time	Тан	10			ns	R/W,RS,E
Data Set-up Time	T <sub>DSW</sub>	80			ns	DB0~DB7
Data Hold Time	T <sub>H</sub>	10			ns	DB0~DB7



### **10.2.2 Read mode**

Characteristic	Symbol	Min	Type	Max	Unit	Test PIN
Enable Cycle Time	$t_{\rm C}$	1200			ns	Е
Enable Pulse Time	$T_{PW}$	480			ns	Е
Enable Rise/Fall Time	$T_{R_{,}}$ $T_{F}$			25	ns	Е
Address Set-up Time	$T_{AS}$	0			ns	R/W,RS,E
Address Hold Time	$T_{AH}$	10			ns	R/W,RS,E
Data Set-up Time	$T_{\mathrm{DDR}}$			320	ns	DB0~DB7
Data Hold Time	$T_{\mathrm{H}}$	10			ns	DB0~DB7



#### 11. INSTRUCTION TABLE

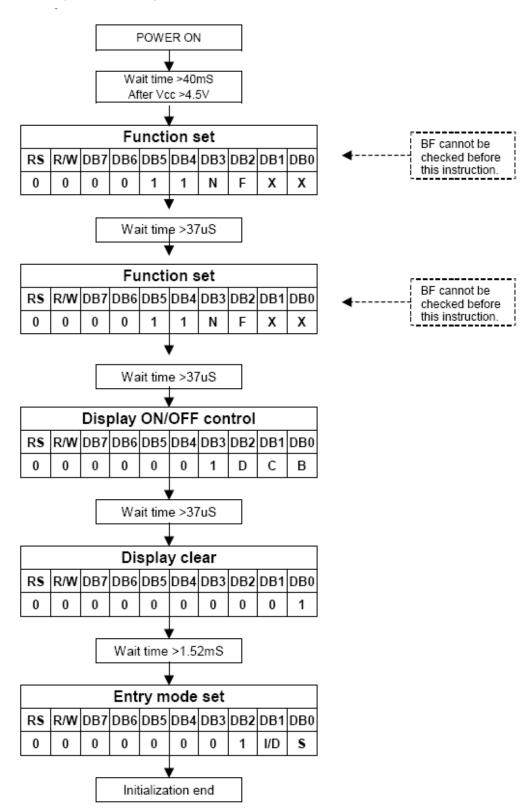
Command	RS	R/W	DB7 I	)B6 D	B5 D	B4	DB3	DB2	DB1	DB0	Execution time (fosc=270KHz)	Remark
Clear Display	0	0	0	0	0	0	0	0	0	1	1.52ms	Write"20H" to DDRAM. And set DDRAM address to "00H" from AC
Return home	0	0	0	0	0	0	0	0	1	Х	1.52ms	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.
Entry mode Set	0	0	0	0	0	0	0	1	I/D	S	37us	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.
Display on/off control	0	0	0	0	0	0	1	D	С	В	37us	D=1: entire display on C=1: cursor on B=1: cursor position on
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	X	X	37us	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.
function Set	0	0	0	0	1	DL	N	F	X	X	37us	DL: interface data is 8/4 bits N: number of line is 2/1 F: font size is 5x11/5x8
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set CGRAM address in address counter
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set DDRAM address in address counter
Read busy flag& address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	0us	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	37us	Write data into internal RAM (DDRAM/CGRAM)
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	37us	Read data from internal RAM (DDRAM / CGRAM)

#### Note:

Be sure the AIP31066 is not in the busy state (BF=00 before sending an instruction from the MPU to the AIP31066. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to instruction table for the list of each instruction execution time.

#### 12. INITIALIZING BY INSTRUCTION

8-bit interface mode (fosc=270kHz)



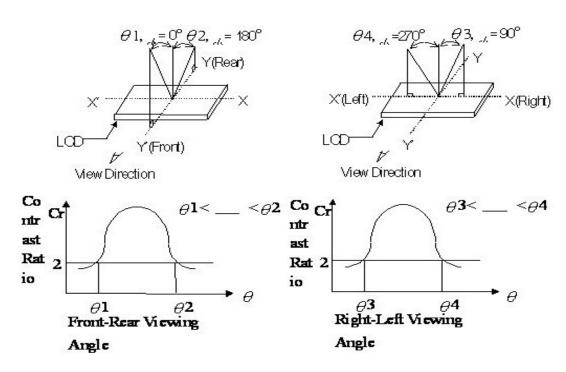
### 13. CHARACTER GENERATOR ROM

002

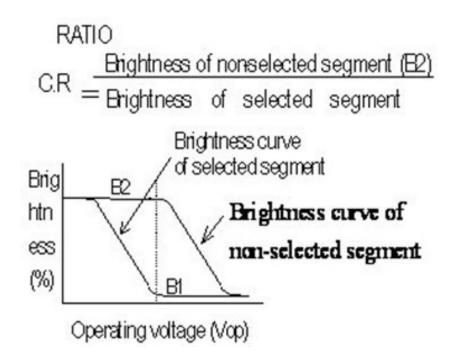
67-64 63-60	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	(7)		8								×	**	100	*		
0111	(8)					W							88			
1000	(1)					×		×								*
1001	(2)											×				
1010	(3)							*				×				
1011	(4)				×											
1100	(5)											W			W	
1101	(6)															
1110	(7)															
1111	(8)															

#### 14. OPTICAL CHARACTERISTICS

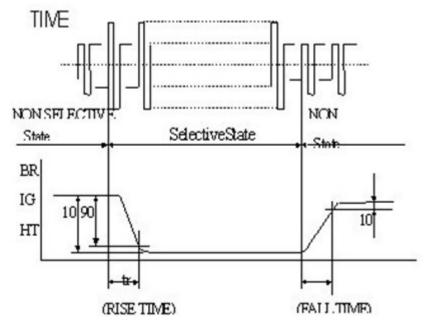
#### 14.1 Definition of Viewing Angle



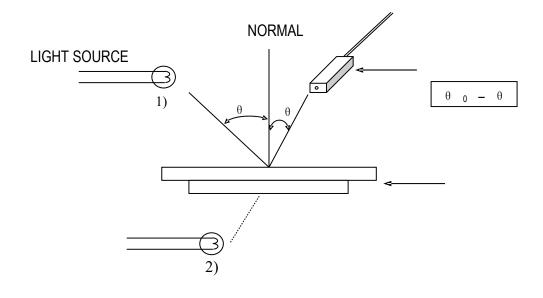
#### 14.2 Definition of Contrast



### 14.3 Definition of Response



#### 14.4 Measuring Instruments For Elector-optical Characteristics



### \* Note:

- 1) Light source position for measuring the reflective type of LCD panel;
- 2) Light source position for measuring the transflective / transmissive types of LCD panel.

### 15. MODULE ACCEPT QUALITY LEVEL (AQL)

15.1 AQL Standard Value: Critical Defect =0.1, Major Defect=0.65; Minor Defect =2.5.

15.2 Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II

#### 16. RELIABILITY TEST

Operating life time: Longer than 75,000 hours

(at room temperature without direct irradiation of sunlight)

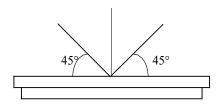
Reliability characteristics shall meet following requirements.

No.	Test Item	Content of Test	<b>Test Condition</b>
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	+80°С 96Н
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	−30°C 96H
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	+70°C 96H
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	−20°C 96H
5	High Temperature/ Humidity Storage	Endurance test applying the high temperature and humidity storage for a long time	40°С 90%RН 96Н
6	Temperature Cycle	Endurance test applying the low and high temperature cycle  -20°C 25°C 70°C 25°C  30min 5min 30min 5min  1 cycle	-20°C/70°C 5 cycles
7	Vibration Test (Package State)	Endurance test applying the vibration during transportation	10Hz - 55Hz, 50m/s,15min
8	Shock Test (Package State)	Endurance test applying the shock during transportation	Half-sinewave, 100m/s, 11ms
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	40 kPa 16 H

#### 17. INSPECTION SPECIFICATION

#### 17.1 Visual Inspection

- 1) Inspect under 2x20W or 40W fluorescent lamp (approximately 3000 lux) leaving 25 to 30 cm between the module and the lamp and 30 cm between the module and the eye (measuring position).
- 2) Appearance is inspected at the best contrast voltage (best contrast is adjusted considering clearness and crosstalk on screen).
- 3) Inspect the module at 45° right and left, top and bottom.
- 4) Use the optimum viewing angle during the contrast inspection.



#### 16.2 Standard of Appearance Inspection

No.	Item	Criteria				
		Round type: as per following drawing				
		=( <b>X</b> + <b>Y</b>	)/2	Acceptable quanti	tv	
			Size	Zone A	Zone B	
			Ф<0.			
			0.1<Ф<0.2		A 1	
	<b>X</b>		0.2<Ф<0.2	25 1	Any number	
			0.25<Ф	0		
	Line type: as per following drawing  Black spot  Acceptable quantity					
		Length	Width	Zone A	Zone B	
1	White spot	_	W≤0.02	Any number		
		L≤3.0	0.02 <w≤0.03< td=""><td>2</td><td></td></w≤0.03<>	2		
	Dust	L≤2.5	0.03 <w≤0.05< td=""><td>2</td><td>Any number</td></w≤0.05<>	2	Any number	
			0.05 <w< td=""><td>As round</td><td></td></w<>	As round		
		_	0.03~W	type		
		L W				
			table quantity: 3	i.u.ad		
2	Polariser scratch	Scratch on protective film is permitted Scratch on polariser: same as No. 1				
3	Polariser bubble	$\Phi = (X+Y)$		. 1		
	1 Olarisci Guddie	$\Phi = (X \mid I)$	)! <del>'</del>			

# **Product Specification**

SECD200	ZXXX NOT SI	<b>- '</b> ////////////////////////////////////		Tiodaci	. Specifica	
			Acceptable quantity			
		X	Size	Zone A	Zone B	
			Ф<0.2	Any number		
		"""""""""""""""""""""""""""""""""""""""	0.2<Ф	2		
			< 0.5	2	Any number	
		Total	0.5<Ф	1	Any number	
			<1.0	1		
		acce	1.0<Ф	0		
		ptabl L	tr., 2			
		e quantit	iy: 3			
		4 1 Pin hole o	on segmented displa	av		
		W: segment v		. y		
		W. segment				
				Acceptable qu	antity	
			Wid	lth	Quantity	
			W≤	Φ≤(		
				5. 1	≤1/2W	
			//////////////////////////////////////	Φ≤0.2		
		•		Φ≤1/3		
				cceptable quantity: 1	defect per	
		4.2 Pin hole of		oles with $\Phi$ unde	er 0.10 mm are	
		dot ma	4	cceptable		
		display		·		
		w		Acceptable quantity		
4	Segment	_	≤0.05.	Size	iore quantity	
7	deformation	۲a	73	a, b<0.1	Any number	
		73		(a+b)/2≤0.1	Any number	
		'		0.5<Ф	Any number	
				<1.0	3	
		Total accepta	ble quantity: 7	1.0		
		Total deseptation quantity.				
		4.3 Segments / dots with different width				
		D				
		Acceptable				
				a≥b	a/b≤4/3	
		A	<u>B</u>	a <b< td=""><td>a/b&gt;4/3</td></b<>	a/b>4/3	
		4 4 A 1'	41 4-6-4			
		_	nt layer defect			
		$\Phi = (A+B)/2$	<u></u>			

# **Product Specification**

ECB20	02XXX-R01 S	SERIES	<u> </u>	Pı	oduct	Speci	fica
		~	8x 7x4				
					Acceptable quantity		y
				$\checkmark$	Þ≤0.4	Any r	numbe
		Δ,		0.	.4<Ф		5
				<b>20</b> f	≤1.0		
		≥ <u>;         </u>		1.	Ф>0		3
			C o		≤1.5		3
			<u>-</u> +   <del>-</del> -	1.	.5<Ф		2
					≤2.0		
		Tota	al acceptable quanti	ty: 7			
5	Colour uniformity	Level of sample for approval set as limit sample					
			backlight colour sh	-		specificat	ion
6	Backlight		hing and or unlit ba	_	ed		
		Dust larger than 0.25 mm is not allowed					
_		Exposed wire bond pad is not allowed					
7	COB	Insufficient covering with resin is not allowed (wire bond line					
		exposed) Dust or bubble on the resin are not allowed  No unmelted solder paste should be present on PCB					
		Cold solder joints, missing solder connections, or oxidation are not					
8	8 PCB	allowed					
0	ТСБ	No residue or solder balls on PCB are allowed					
			Short circuits on components are not allowed				
		Acceptable quantity					
				Size		antity	
				Φ<0.2		number	
9	Tray particles		On tray	Ф>0.25	7 111.9	4	
				Φ ≥0.25		2	
			On display	L = 3		1	

#### 18. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protection foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - -Be sure to ground the body when handling the LCD module.
  - -Tools required for assembly, such as soldering irons, must be properly grounded.
  - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

#### ■ Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent—static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below  $0\,^{\circ}\text{C}$ ). Whenever possible, the LCD modules should be stored in the same conditions in which they

were shipped from our company.

#### 19. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
  - Exposed area of the printed circuit board
  - Terminal electrode sections